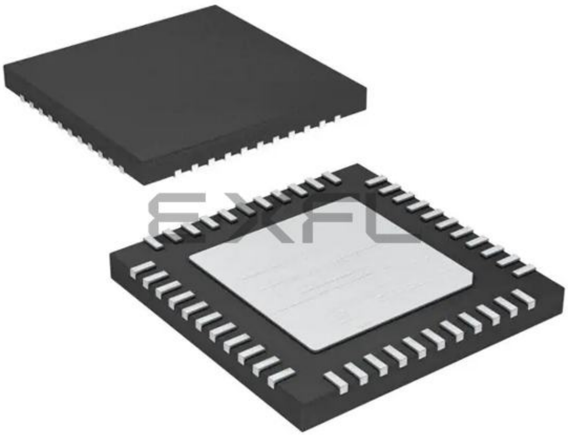
Microchip Technology - PIC16LF77-I/ML Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf77-i-ml

MICROCHIP

PIC16F7X

28/40-Pin 8-Bit CMOS FLASH Microcontrollers

Devices Included in this Data Sheet:

- PIC16F73
- PIC16F74
- PIC16F76
- PIC16F77

High Performance RISC CPU:

- High performance RISC CPU
- Only 35 single word instructions to learn
- All single cycle instructions except for program branches which are two-cycle
- Operating speed: DC - 20 MHz clock input
  DC - 200 ns instruction cycle
- Up to 8K x 14 words of FLASH Program Memory, Up to 368 x 8 bytes of Data Memory (RAM)
- Pinout compatible to the PIC16C73B/74B/76/77
- Pinout compatible to the PIC16F873/874/876/877
- Interrupt capability (up to 12 sources)
- Eight level deep hardware stack
- Direct, Indirect and Relative Addressing modes
- Processor read access to program memory

Special Microcontroller Features:

- Power-on Reset (POR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- Programmable code protection
- Power saving SLEEP mode
- Selectable oscillator options
- In-Circuit Serial Programming™ (ICSP™) via two pins

Peripheral Features:

- Timer0: 8-bit timer/counter with 8-bit prescaler
- Timer1: 16-bit timer/counter with prescaler, can be incremented during SLEEP via external crystal/clock
- Timer2: 8-bit timer/counter with 8-bit period register, prescaler and postscaler
- Two Capture, Compare, PWM modules
  - Capture is 16-bit, max. resolution is 12.5 ns
  - Compare is 16-bit, max. resolution is 200 ns
  - PWM max. resolution is 10-bit
- 8-bit, up to 8-channel Analog-to-Digital converter
- Synchronous Serial Port (SSP) with SPI™ (Master mode) and I^2C™ (Slave)
- Universal Synchronous Asynchronous Receiver Transmitter (USART/SCI)
- Parallel Slave Port (PSP), 8-bits wide with external $\overline{RD}$, $\overline{WR}$ and $\overline{CS}$ controls (40/44-pin only)
- Brown-out detection circuitry for Brown-out Reset (BOR)

CMOS Technology:

- Low power, high speed CMOS FLASH technology
- Fully static design
- Wide operating voltage range: 2.0V to 5.5V
- High Sink/Source Current: 25 mA
- Industrial temperature range
- Low power consumption:
  - < 2 mA typical @ 5V, 4 MHz
  - 20 μA typical @ 3V, 32 kHz
  - < 1 μA typical standby current

Device	Program Memory (# Single Word Instructions)	Data SRAM (Bytes)	I/O	Interrupts	8-bit A/D (ch)	CCP (PWM)	SSP		USART	Timers 8/16-bit
							SPI (Master)	I^2C (Slave)		
PIC16F73	4096	192	22	11	5	2	Yes	Yes	Yes	2 / 1
PIC16F74	4096	192	33	12	8	2	Yes	Yes	Yes	2 / 1
PIC16F76	8192	368	22	11	5	2	Yes	Yes	Yes	2 / 1
PIC16F77	8192	368	33	12	8	2	Yes	Yes	Yes	2 / 1

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TABLE 1-2: PIC16F73 AND PIC16F76 PINOUT DESCRIPTION (CONTINUED)

Pin Name	DIP SSOP SOIC Pin#	MLF Pin#	I/O/P Type	Buffer Type	Description
					PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT	21	18		TTL/ST(1)	
RB0			I/O		Digital I/O.
INT			I		External interrupt.
RB1	22	19	I/O	TTL	Digital I/O.
RB2	23	20	I/O	TTL	Digital I/O.
RB3/PGM	24	21		TTL	
RB3			I/O		Digital I/O.
PGM			I/O		Low voltage ICSP programming enable pin.
RB4	25	22	I/O	TTL	Digital I/O.
RB5	26	23	I/O	TTL	Digital I/O.
RB6/PGC	27	24		TTL/ST(2)	
RB6			I/O		Digital I/O.
PGC			I/O		In-Circuit Debugger and ICSP programming clock.
RB7/PGD	28	25		TTL/ST(2)	
RB7			I/O		Digital I/O.
PGD			I/O		In-Circuit Debugger and ICSP programming data.
					PORTC is a bi-directional I/O port.
RC0/T1OSO/T1CKI	11	8		ST	
RC0			I/O		Digital I/O.
T1OSO			O		Timer1 oscillator output.
T1CKI			I		Timer1 external clock input.
RC1/T1OSI/CCP2	12	9		ST	
RC1			I/O		Digital I/O.
T1OSI			I		Timer1 oscillator input.
CCP2			I/O		Capture2 input, Compare2 output, PWM2 output.
RC2/CCP1	13	10		ST	
RC2			I/O		Digital I/O.
CCP1			I/O		Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	14	11		ST	
RC3			I/O		Digital I/O.
SCK			I/O		Synchronous serial clock input/output for SPI mode.
SCL			I/O		Synchronous serial clock input/output for I^{2}C mode.
RC4/SDI/SDA	15	12		ST	
RC4			I/O		Digital I/O.
SDI			I		SPI data in.
SDA			I/O		I^{2}C data I/O.
RC5/SDO	16	13		ST	
RC5			I/O		Digital I/O.
SDO			O		SPI data out.
RC6/TX/CK	17	14		ST	
RC6			I/O		Digital I/O.
TX			O		USART asynchronous transmit.
CK			I/O		USART 1 synchronous clock.
RC7/RX/DT	18	15		ST	
RC7			I/O		Digital I/O.
RX			I		USART asynchronous receive.
DT			I/O		USART synchronous data.
VSS	8, 19	5, 16	P	—	Ground reference for logic and I/O pins.
VDD	20	17	P	—	Positive supply for logic and I/O pins.

Legend: I = input O = output I/O = input/output P = power
— = Not used TTL = TTL input ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.
2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.
3: This buffer is a Schmitt Trigger input when configured in RC Oscillator mode and a CMOS input otherwise.

TABLE 1-3: PIC16F74 AND PIC16F77 PINOUT DESCRIPTION

Pin Name	DIP Pin#	PLCC Pin#	QFP Pin#	I/O/P Type	Buffer Type	Description
OSC1/CLKI	13	14	30		ST/CMOS[(4)]	Oscillator crystal or external clock input.
OSC1				I		Oscillator crystal input or external clock source input. ST buffer when configured in RC mode. Otherwise CMOS.
CLKI				I		External clock source input. Always associated with pin function OSC1 (see OSC1/CLKI, OSC2/CLKO pins).
OSC2/CLKO	14	15	31		—	Oscillator crystal or clock output.
OSC2				O		Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO				O		In RC mode, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
$\overline{\text{MCLR}}$/VPP	1	2	18		ST	Master Clear (input) or programming voltage (output).
$\overline{\text{MCLR}}$				I		Master Clear (Reset) input. This pin is an active low RESET to the device.
VPP				P		Programming voltage input.
						PORTA is a bi-directional I/O port.
RA0/AN0	2	3	19		TTL	
RA0				I/O		Digital I/O.
AN0				I		Analog input 0.
RA1/AN1	3	4	20		TTL	
RA1				I/O		Digital I/O.
AN1				I		Analog input 1.
RA2/AN2	4	5	21		TTL	
RA2				I/O		Digital I/O.
AN2				I		Analog input 2.
RA3/AN3/VREF	5	6	22		TTL	
RA3				I/O		Digital I/O.
AN3				I		Analog input 3.
VREF				I		A/D reference voltage input.
RA4/T0CKI	6	7	23		ST	
RA4				I/O		Digital I/O – Open drain when configured as output.
T0CKI				I		Timer0 external clock input.
RA5/$\overline{\text{SS}}$/AN4	7	8	24		TTL	
RA5				I/O		Digital I/O.
$\overline{\text{SS}}$				I		SPI slave select input.
AN4				I		Analog input 4.

Legend: I = input O = output I/O = input/output P = power
— = Not used TTL = TTL input ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as an external interrupt.

2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

3: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

4: This buffer is a Schmitt Trigger input when configured in RC Oscillator mode and a CMOS input otherwise.

TABLE 2-1: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page
Bank 1											
80h[4]	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	27, 96
81h	OPTION_REG	$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	20, 44, 96
82h[4]	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	26, 96
83h[4]	STATUS	IRP	RP1	RP0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	19, 96
84h[4]	FSR	Indirect data memory address pointer								xxxx xxxx	27, 96
85h	TRISA	—	—	PORTA Data Direction Register						--11 1111	32, 96
86h	TRISB	PORTB Data Direction Register								1111 1111	34, 96
87h	TRISC	PORTC Data Direction Register								1111 1111	35, 96
88h[5]	TRISD	PORTD Data Direction Register								1111 1111	36, 96
89h[5]	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Data Direction Bits			0000 -111	38, 96
8Ah[1,4]	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter					---0 0000	21, 96
8Bh[4]	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	23, 96
8Ch	PIE1	PSPIE[3]	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	22, 96
8Dh	PIE2	—	—	—	—	—	—	—	CCP2IE	---- ---0	24, 97
8Eh	PCON	—	—	—	—	—	—	$\overline{\text{POR}}$	BOR	---- --qq	25, 97
8Fh	—	Unimplemented								—	—
90h	—	Unimplemented								—	—
91h	—	Unimplemented								—	—
92h	PR2	Timer2 Period Register								1111 1111	52, 97
93h	SSPADD	Synchronous Serial Port (I^2C mode) Address Register								0000 0000	68, 97
94h	SSPSTAT	SMP	CKE	D/$\overline{\text{A}}$	P	S	R/$\overline{\text{W}}$	UA	BF	0000 0000	60, 97
95h	—	Unimplemented								—	—
96h	—	Unimplemented								—	—
97h	—	Unimplemented								—	—
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	69, 97
99h	SPBRG	Baud Rate Generator Register								0000 0000	71, 97
9Ah	—	Unimplemented								—	
9Bh	—	Unimplemented								—	
9Ch	—	Unimplemented								—	
9Dh	—	Unimplemented								—	
9Eh	—	Unimplemented								—	
9Fh	ADCON1	—	—	—	—	—	PCFG2	PCFG1	PCFG0	---- -000	84, 97

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.
Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8>, whose contents are transferred to the upper byte of the program counter during branches (CALL or GOTO).

2: Other (non power-up) RESETS include external RESET through $\overline{\text{MCLR}}$ and Watchdog Timer Reset.

3: Bits PSPIE and PSPIF are reserved on the 28-pin devices; always maintain these bits clear.

4: These registers can be addressed from any bank.

5: PORTD, PORTE, TRISD, and TRISE are not physically implemented on the 28-pin devices, read as '0'.

6: This bit always reads as a '1'.

TABLE 2-1: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page
Bank 2											
100h(4)	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	27, 96
101h	TMR0	Timer0 Module Register								xxxx xxxx	45, 96
102h(4)	PCL	Program Counter (PC) Least Significant Byte								0000 0000	26, 96
103h(4)	STATUS	IRP	RP1	RP0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	19, 96
104h(4)	FSR	Indirect Data Memory Address Pointer								xxxx xxxx	27, 96
105h	—	Unimplemented								—	—
106h	PORTB	PORTB Data Latch when written: PORTB pins when read								xxxx xxxx	34, 96
107h	—	Unimplemented								—	—
108h	—	Unimplemented								—	—
109h	—	Unimplemented								—	—
10Ah(1,4)	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter					---0 0000	21, 96
10Bh(4)	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	23, 96
10Ch	PMDATA	Data Register Low Byte								xxxx xxxx	29, 97
10Dh	PMADR	Address Register Low Byte								xxxx xxxx	29, 97
10Eh	PMDATH	—	—	Data Register High Byte						xxxx xxxx	29, 97
10Fh	PMADRH	—	—	—	Address Register High Byte					xxxx xxxx	29, 97
Bank 3											
180h(4)	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	27, 96
181h	OPTION_REG	$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	20, 44, 96
182h(4)	PCL	Program Counter (PC) Least Significant Byte								0000 0000	26, 96
183h(4)	STATUS	IRP	RP1	RP0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	19, 96
184h(4)	FSR	Indirect Data Memory Address Pointer								xxxx xxxx	27, 96
185h	—	Unimplemented								—	—
186h	TRISB	PORTB Data Direction Register								1111 1111	34, 96
187h	—	Unimplemented								—	—
188h	—	Unimplemented								—	—
189h	—	Unimplemented								—	—
18Ah(1,4)	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter					---0 0000	21, 96
18Bh(4)	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	23, 96
18Ch	PMCON1	—(6)	—	—	—	—	—	—	RD	1--- ---0	29, 97
18Dh	—	Unimplemented								—	
18Eh	—	Reserved maintain clear								0000 0000	
18Fh	—	Reserved maintain clear								0000 0000	

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.
Shaded locations are unimplemented, read as ‘0’.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8>, whose contents are transferred to the upper byte of the program counter during branches (CALL or GOTO).

2: Other (non power-up) RESETS include external RESET through $\overline{\text{MCLR}}$ and Watchdog Timer Reset.

3: Bits PSPIE and PSPIF are reserved on the 28-pin devices; always maintain these bits clear.

4: These registers can be addressed from any bank.

5: PORTD, PORTE, TRISD, and TRISE are not physically implemented on the 28-pin devices, read as ‘0’.

6: This bit always reads as a ‘1’.

3.0 READING PROGRAM MEMORY

The FLASH Program Memory is readable during normal operation over the entire VDD range. It is indirectly addressed through Special Function Registers (SFR). Up to 14-bit numbers can be stored in memory for use as calibration parameters, serial numbers, packed 7-bit ASCII, etc. Executing a program memory location containing data that forms an invalid instruction results in a NOP.

There are five SFRs used to read the program and memory. These registers are:

- PMCON1
- PMDATA
- PMDATH
- PMADR
- PMADRH

The program memory allows word reads. Program memory access allows for checksum calculation and reading calibration tables.

When interfacing to the program memory block, the PMDATH:PMDATA registers form a two-byte word, which holds the 14-bit data for reads. The PMADRH:PMADR registers form a two-byte word, which holds the 13-bit address of the FLASH location being accessed. These devices can have up to 8K words of program FLASH, with an address range from 0h to 3FFFh. The unused upper bits in both the PMDATH and PMADRH registers are not implemented and read as “0’s”.

3.1 PMADR

The address registers can address up to a maximum of 8K words of program FLASH.

When selecting a program address value, the MSByte of the address is written to the PMADRH register and the LSByte is written to the PMADR register. The upper MSbits of PMADRH must always be clear.

3.2 PMCON1 Register

PMCON1 is the control register for memory accesses.

The control bit RD initiates read operations. This bit cannot be cleared, only set, in software. It is cleared in hardware at the completion of the read operation.

REGISTER 3-1: PMCON1 REGISTER (ADDRESS 18Ch)

R-1	U-0	U-0	U-0	U-x	U-0	U-0	R/S-0
reserved	—	—	—	—	—	—	RD
bit 7							bit 0

bit 7 **Reserved:** Read as ‘1’

bit 6-1 **Unimplemented**: Read as '0'

bit 0 **RD**: Read Control bit

1 = Initiates a FLASH read, RD is cleared in hardware. The RD bit can only be set (not cleared) in software.

0 = FLASH read completed

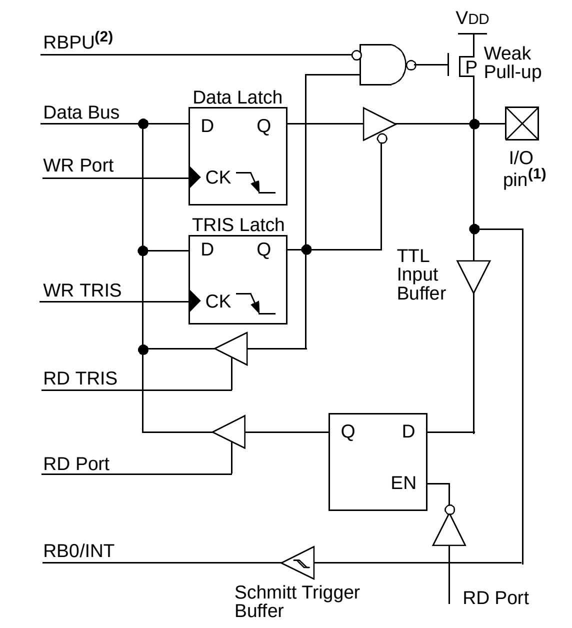
Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR reset	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

4.2 PORTB and the TRISB Register

PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. Setting a TRISB bit (= '1') will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISB bit (= '0') will make the corresponding PORTB pin an output (i.e., put the contents of the output latch on the selected pin).

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit $\overline{\text{RBPU}}$ (OPTION_REG<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

FIGURE 4-3: BLOCK DIAGRAM OF RB3:RB0 PINS



Note 1: I/O pins have diode protection to VDD and VSS.

2: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the $\overline{\text{RBPU}}$ bit (OPTION_REG<7>).

Four of the PORTB pins (RB7:RB4) have an interrupt-on-change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupt-on-change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are ORed together to generate the RB Port Change Interrupt with flag bit RBIF (INTCON<0>).

This interrupt can wake the device from SLEEP. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

a) Any read or write of PORTB. This will end the mismatch condition.

b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

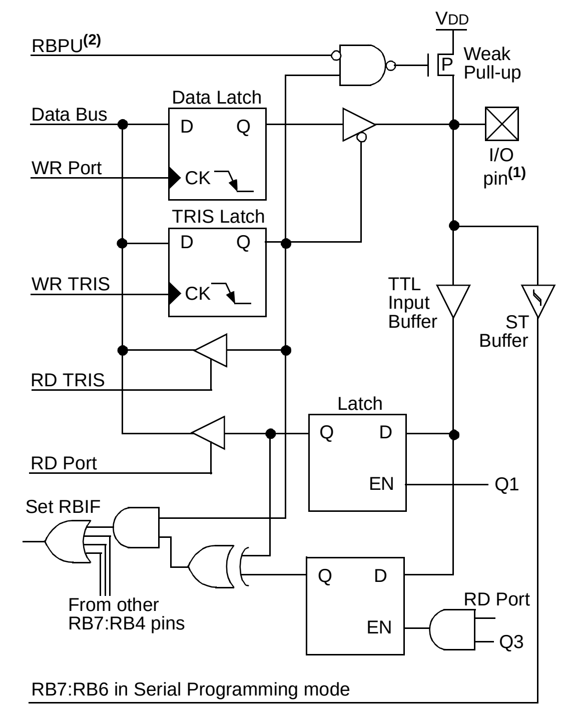
The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

This interrupt on mismatch feature, together with software configureable pull-ups on these four pins, allow easy interface to a keypad and make it possible for wake-up on key depression. Refer to the Embedded Control Handbook, "Implementing Wake-up on Key Stroke" (AN552).

RB0/INT is an external interrupt input pin and is configured using the INTEDG bit (OPTION_REG<6>).

RB0/INT is discussed in detail in Section 12.11.1.

FIGURE 4-4: BLOCK DIAGRAM OF RB7:RB4 PINS



Note 1: I/O pins have diode protection to VDD and VSS.

2: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the $\overline{\text{RBPU}}$ bit (OPTION_REG<7>).

4.6 Parallel Slave Port

The Parallel Slave Port (PSP) is not implemented on the PIC16F73 or PIC16F76.

PORTD operates as an 8-bit wide Parallel Slave Port, or Microprocessor Port, when control bit PSPMODE (TRISE<4>) is set. In Slave mode, it is asynchronously readable and writable by an external system using the read control input pin RE0/$\overline{RD}$, the write control input pin RE1/$\overline{WR}$, and the chip select control input pin RE2/$\overline{CS}$.

The PSP can directly interface to an 8-bit microprocessor data bus. The external microprocessor can read or write the PORTD latch as an 8-bit latch. Setting bit PSPMODE enables port pin RE0/$\overline{RD}$ to be the $\overline{RD}$ input, RE1/$\overline{WR}$ to be the $\overline{WR}$ input and RE2/$\overline{CS}$ to be the $\overline{CS}$ (chip select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (i.e., set). The A/D port configuration bits PCFG3:PCFG0 (ADCON1<3:0>) must be set to configure pins RE2:RE0 as digital I/O.

There are actually two 8-bit latches, one for data output (external reads) and one for data input (external writes). The firmware writes 8-bit data to the PORTD output data latch and reads data from the PORTD input data latch (note that they have the same address). In this mode, the TRISD register is ignored, since the external device is controlling the direction of data flow.

An external write to the PSP occurs when the $\overline{CS}$ and $\overline{WR}$ lines are both detected low. Firmware can read the actual data on the PORTD pins during this time. When either the CS or WR lines become high (level triggered), the data on the PORTD pins is latched, and the Input Buffer Full (IBF) status flag bit (TRISE<7>) and interrupt flag bit PSPIF (PIR1<7>) are set on the Q4 clock cycle, following the next Q2 cycle to signal the write is complete (Figure 4-9). Firmware clears the IBF flag by reading the latched PORTD data, and clears the PSPIF bit.

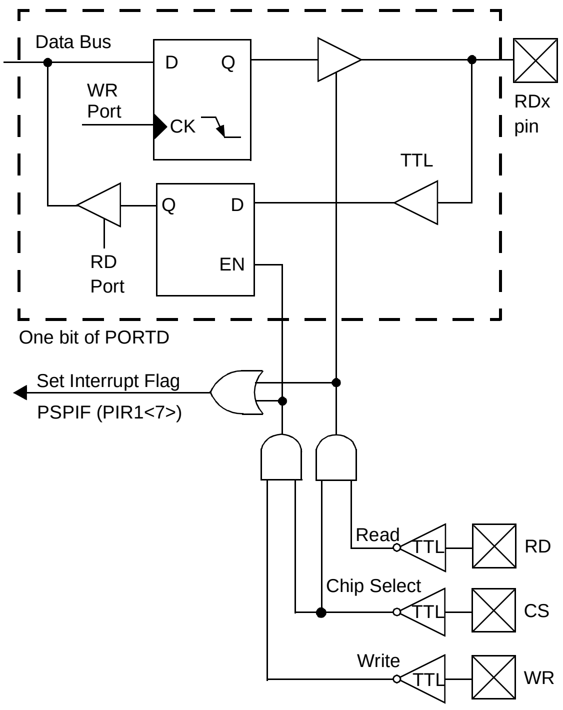
The Input Buffer Overflow (IBOV) status flag bit (TRISE<5>) is set if an external write to the PSP occurs while the IBF flag is set from a previous external write. The previous PORTD data is overwritten with the new data. IBOV is cleared by reading PORTD and clearing IBOV.

A read from the PSP occurs when both the $\overline{CS}$ and $\overline{RD}$ lines are detected low. The data in the PORTD output latch is output to the PORTD pins. The Output Buffer Full (OBF) status flag bit (TRISE<6>) is cleared immediately (Figure 4-10), indicating that the PORTD latch is being read, or has been read by the external bus. If firmware writes new data to the output latch during this time, it is immediately output to the PORTD pins, but OBF will remain cleared.

When either the $\overline{CS}$ or $\overline{RD}$ pins are detected high, the PORTD outputs are disabled, and the interrupt flag bit PSPIF is set on the Q4 clock cycle following the next Q2 cycle, indicating that the read is complete. OBF remains low until firmware writes new data to PORTD.

When not in PSP mode, the IBF and OBF bits are held clear. Flag bit IBOV remains unchanged. The PSPIF bit must be cleared by the user in firmware; the interrupt can be disabled by clearing the interrupt enable bit PSPIE (PIE1<7>).

FIGURE 4-8: PORTD AND PORTE BLOCK DIAGRAM (PARALLEL SLAVE PORT)



Note: I/O pin has protection diodes to VDD and VSS.

FIGURE 4-9: PARALLEL SLAVE PORT WRITE WAVEFORMS

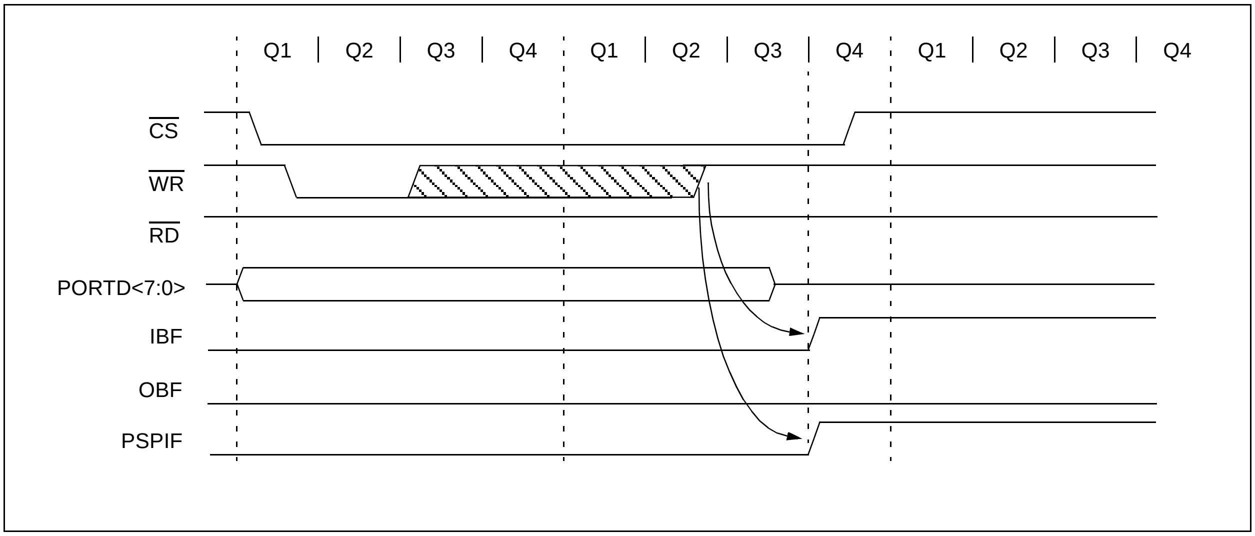


FIGURE 4-10: PARALLEL SLAVE PORT READ WAVEFORMS

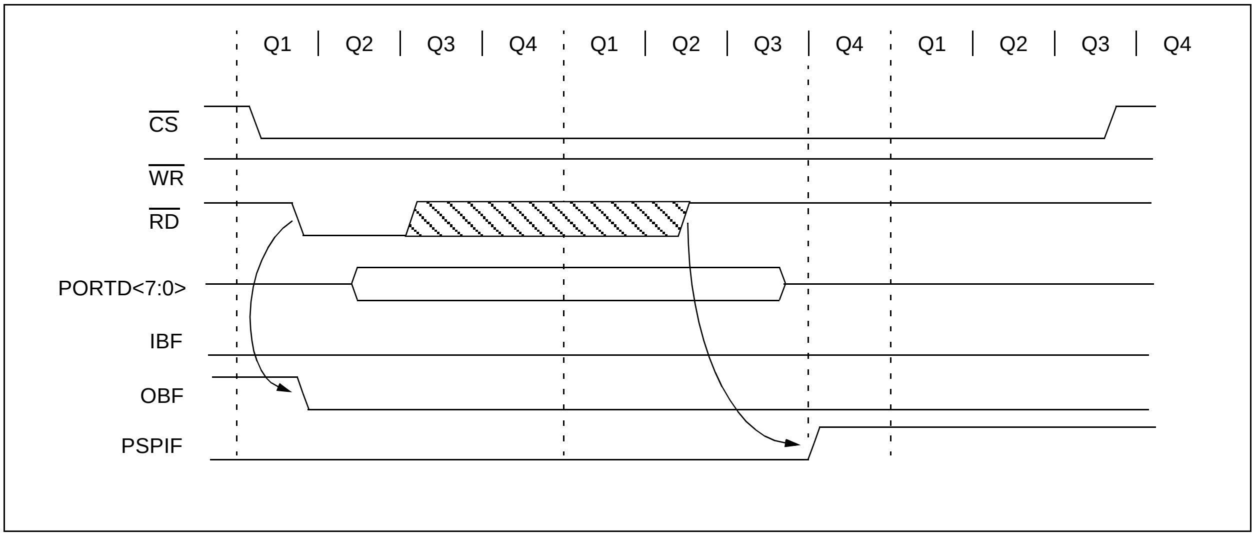


TABLE 4-11: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
08h	PORTD	Port data latch when written: Port pins when read								`xxxx xxxx`	`uuuu uuuu`
09h	PORTE	—	—	—	—	—	RE2	RE1	RE0	`---- -xxx`	`---- -uuu`
89h	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Data Direction Bits			`0000 -111`	`0000 -111`
0Ch	PIR1	PSPIF[(1)]	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	`0000 0000`	`0000 0000`
8Ch	PIE1	PSPIE[(1)]	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	`0000 0000`	`0000 0000`
9Fh	ADCON1	—	—	—	—	—	PCFG2	PCFG1	PCFG0	`---- -000`	`---- -000`

Legend: `x` = unknown, `u` = unchanged, `-` = unimplemented, read as '0'. Shaded cells are not used by the Parallel Slave Port.

Note 1: Bits PSPIE and PSPIF are reserved on the PIC16F73/76; always maintain these bits clear.

6.1 Timer1 Operation in Timer Mode

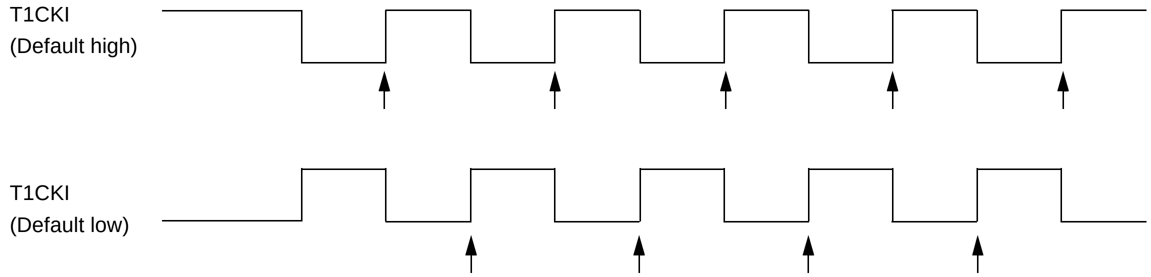
Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is FOSC/4. The synchronize control bit $\overline{\text{T1SYNC}}$ (T1CON<2>) has no effect, since the internal clock is always in sync.

6.2 Timer1 Counter Operation

Timer1 may operate in Asynchronous or Synchronous mode, depending on the setting of the TMR1CS bit.

When Timer1 is being incremented via an external source, increments occur on a rising edge. After Timer1 is enabled in Counter mode, the module must first have a falling edge before the counter begins to increment.

FIGURE 6-1: TIMER1 INCREMENTING EDGE



Note: Arrows indicate counter increments.

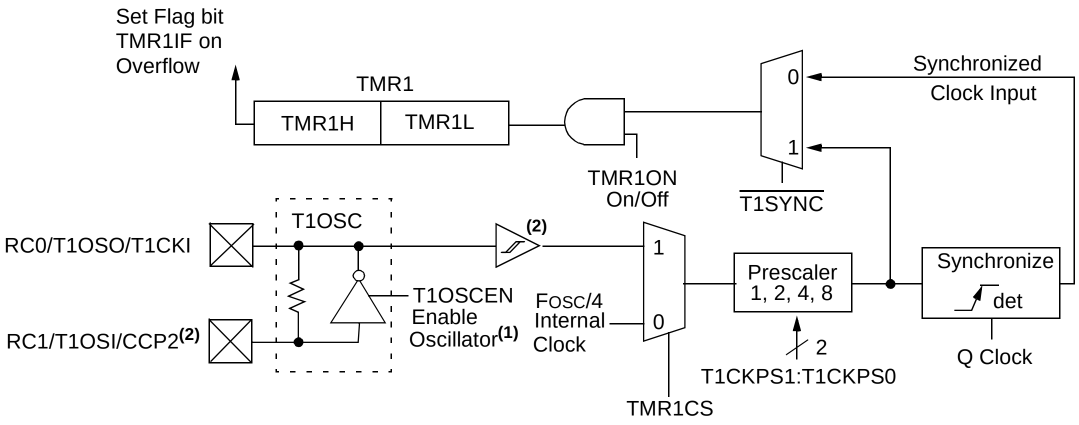
6.3 Timer1 Operation in Synchronized Counter Mode

Counter mode is selected by setting bit TMR1CS. In this mode, the timer increments on every rising edge of clock input on pin RC1/T1OSI/CCP2, when bit T1OSCEN is set, or on pin RC0/T1OSO/T1CKI, when bit T1OSCEN is cleared.

If $\overline{\text{T1SYNC}}$ is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if the external clock is present, since the synchronization circuit is shut-off. The prescaler, however, will continue to increment.

FIGURE 6-2: TIMER1 BLOCK DIAGRAM



Note 1: When the T1OSCEN bit is cleared, the inverter is turned off. This eliminates power drain.

2: For the PIC16F73/76, the Schmitt Trigger is not implemented in External Clock mode.

10.2 USART Asynchronous Mode

In this mode, the USART uses standard non-return-to-zero (NRZ) format (one START bit, eight or nine data bits, and one STOP bit). The most common data format is 8-bits. An on-chip, dedicated, 8-bit baud rate generator can be used to derive standard baud rate frequencies from the oscillator. The USART transmits and receives the LSb first. The USART's transmitter and receiver are functionally independent, but use the same data format and baud rate. The baud rate generator produces a clock, either x16 or x64 of the bit shift rate, depending on bit BRGH (TXSTA<2>). Parity is not supported by the hardware, but can be implemented in software (and stored as the ninth data bit). Asynchronous mode is stopped during SLEEP.

Asynchronous mode is selected by clearing bit SYNC (TXSTA<4>).

The USART Asynchronous module consists of the following important elements:

- Baud Rate Generator
- Sampling Circuit
- Asynchronous Transmitter
- Asynchronous Receiver

10.2.1 USART ASYNCHRONOUS TRANSMITTER

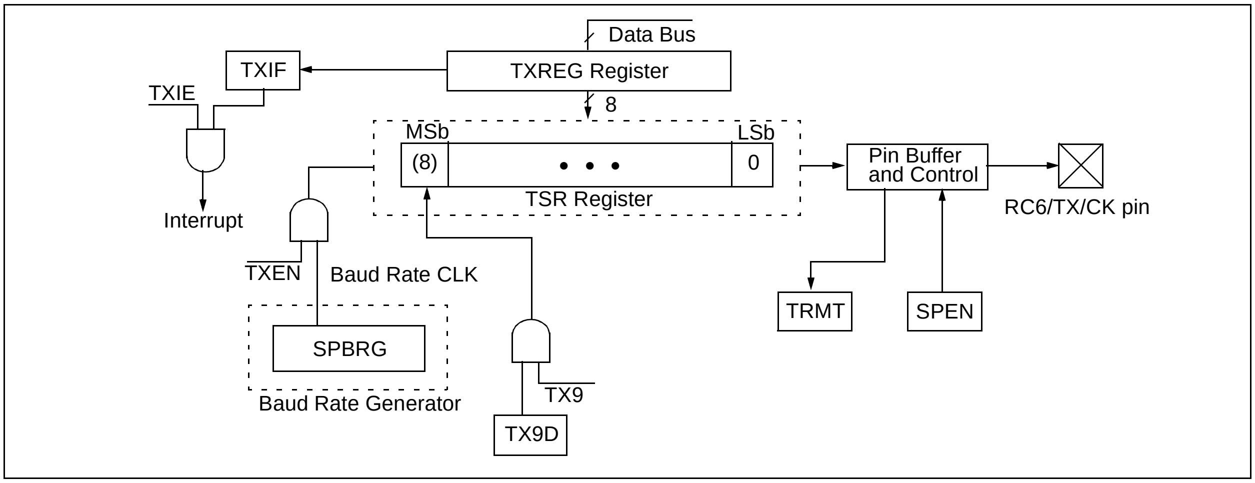
The USART transmitter block diagram is shown in Figure 10-1. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer, TXREG. The TXREG register is loaded with data by firmware. The TSR register is not loaded until the STOP bit has been transmitted from the previous load. As soon as the STOP bit is transmitted, the TSR is loaded with new data from the TXREG register (if available). Once the TXREG register transfers the data to the TSR register, the TXREG register is empty. One instruction cycle later, flag bit TXIF (PIR1<4>) and flag bit TRMT (TXSTA<1>) are set. The TXIF interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set, regardless of the state of enable bit TXIE and cannot be cleared in software. It will reset only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit TRMT (TXSTA<1>) shows the status of the TSR register. Status bit TRMT is a read only bit, which is set one instruction cycle after the TSR register becomes empty, and is cleared one instruction cycle after the TSR register is loaded. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty.

Note	**1:**	The TSR register is not mapped in data memory, so it is not available to the user.
	2:	Flag bit TXIF is set when enable bit TXEN is set. TXIF is cleared by loading TXREG.

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data and the baud rate generator (BRG) has produced a shift clock (Figure 10-2). The transmission can also be started by first loading the TXREG register and then setting enable bit TXEN. Normally, when transmission is first started, the TSR register is empty. At that point, transfer to the TXREG register will result in an immediate transfer to TSR, resulting in an empty TXREG. A back-to-back transfer is thus possible (Figure 10-3). Clearing enable bit TXEN during a transmission will cause the transmission to be aborted and will reset the transmitter. As a result, the RC6/TX/CK pin will revert to hi-impedance.

In order to select 9-bit transmission, transmit bit TX9 (TXSTA<6>) should be set and the ninth bit should be written to TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG register can result in an immediate transfer of the data to the TSR register (if the TSR is empty). In such a case, an incorrect ninth data bit may be loaded in the TSR register.

FIGURE 10-1: USART TRANSMIT BLOCK DIAGRAM



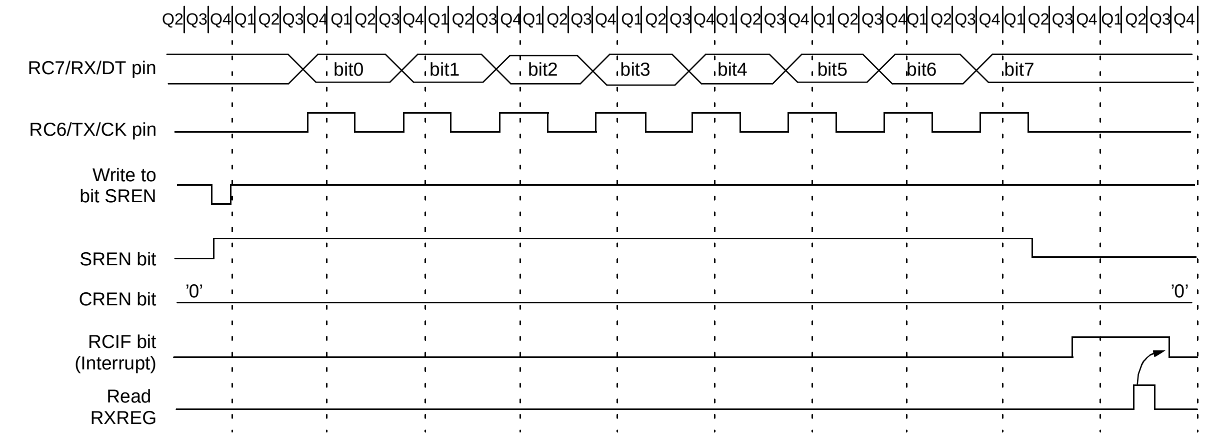
10.3.2 USART SYNCHRONOUS MASTER RECEPTION

Once synchronous mode is selected, reception is enabled by setting either enable bit SREN (RCSTA<5>), or enable bit CREN (RCSTA<4>). Data is sampled on the RC7/RX/DT pin on the falling edge of the clock. If enable bit SREN is set, then only a single word is received. If enable bit CREN is set, the reception is continuous until CREN is cleared. If both bits are set, CREN takes precedence. After clocking the last bit, the received data in the Receive Shift Register (RSR) is transferred to the RCREG register (if it is empty). When the transfer is complete, interrupt flag bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit, which is reset by the hardware. In this case, it is reset when the RCREG register has been read and is empty. The RCREG is a double buffered register (i.e., it is a two deep FIFO). It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting into the RSR register. On the clocking of the last bit of the third byte, if the RCREG register is still full, then overrun error bit OERR (RCSTA<1>) is set. The word in the RSR will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Bit OERR has to be cleared in software (by clearing bit CREN). If bit OERR is set, transfers from the RSR to the RCREG are inhibited, so it is essential to clear bit OERR if it is set. The ninth receive bit is buffered the same way as the receive data. Reading the RCREG register will load bit RX9D with a new value, therefore, it is essential for the user to read the RCSTA register before reading RCREG, in order not to lose the old RX9D information.

Steps to follow when setting up a Synchronous Master Reception:

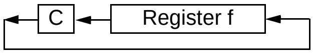
1. Initialize the SPBRG register for the appropriate baud rate (Section 10.1).
2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
3. Ensure bits CREN and SREN are clear.
4. If interrupts are desired, then set enable bit RCIE.
5. If 9-bit reception is desired, then set bit RX9.
6. If a single reception is required, set bit SREN. For continuous reception set bit CREN.
7. Interrupt flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE was set.
8. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
9. Read the 8-bit received data by reading the RCREG register.
10. If any error occurred, clear the error by clearing bit CREN.
11. If using interrupts, ensure that GIE and PEIE in the INTCON register are set.

FIGURE 10-8: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)


Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4
RC7/RX/DT pin
bit0
bit1
bit2
bit3
bit4
bit5
bit6
bit7
RC6/TX/CK pin
Write to bit SREN
SREN bit
CREN bit
'0'
'0'
RCIF bit (Interrupt)
Read RXREG

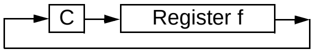
Note: Timing diagram demonstrates Sync Master mode with bit SREN = '1' and bit BRG = '0'.

RLF	Rotate Left f through Carry
Syntax:	[*label*] RLF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	See description below
Status Affected:	C
Description:	The contents of register ’f’ are rotated one bit to the left through the Carry Flag. If ’d’ is 0, the result is placed in the W register. If ’d’ is 1, the result is stored back in register ’f’.



RETURN	Return from Subroutine
Syntax:	[*label*] RETURN
Operands:	None
Operation:	TOS → PC
Status Affected:	None
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.

RRF	Rotate Right f through Carry
Syntax:	[*label*] RRF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	See description below
Status Affected:	C
Description:	The contents of register ’f’ are rotated one bit to the right through the Carry Flag. If ’d’ is 0, the result is placed in the W register. If ’d’ is 1, the result is placed back in register ’f’.



SLEEP	
Syntax:	[*label*] SLEEP
Operands:	None
Operation:	00h → WDT, 0 → WDT prescaler, 1 → $\overline{\text{TO}}$, 0 → $\overline{\text{PD}}$
Status Affected:	$\overline{\text{TO}}$, $\overline{\text{PD}}$
Description:	The power-down status bit, $\overline{\text{PD}}$ is cleared. Time-out status bit, $\overline{\text{TO}}$ is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped.

SUBLW	Subtract W from Literal
Syntax:	[*label*] SUBLW k
Operands:	0 ≤ k ≤ 255
Operation:	k - (W) → (W)
Status Affected:	C, DC, Z
Description:	The W register is subtracted (2’s complement method) from the eight-bit literal 'k'. The result is placed in the W register.

SUBWF	Subtract W from f
Syntax:	[*label*] SUBWF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) - (W) → (destination)
Status Affected:	C, DC, Z
Description:	Subtract (2’s complement method) W register from register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

SWAPF	Swap Nibbles in f
Syntax:	[*label*] SWAPF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f<3:0>) → (destination<7:4>), (f<7:4>) → (destination<3:0>)
Status Affected:	None
Description:	The upper and lower nibbles of register ’f’ are exchanged. If ’d’ is 0, the result is placed in the W register. If ’d’ is 1, the result is placed in register ’f’.

XORLW	Exclusive OR Literal with W
Syntax:	[*label*] XORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .XOR. k → (W)
Status Affected:	Z
Description:	The contents of the W register are XOR’ed with the eight-bit literal 'k'. The result is placed in the W register.

XORWF	Exclusive OR W with f
Syntax:	[*label*] XORWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .XOR. (f) → (destination)
Status Affected:	Z
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

15.1 DC Characteristics: PIC16F73/74/76/77 (Industrial, Extended) PIC16LF73/74/76/77 (Industrial) (Continued)

PIC16LF73/74/76/77 (Industrial)	**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial
PIC16F73/74/76/77 (Industrial, Extended)	**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	IDD	**Supply Current (Notes 2, 5)**					
D010		PIC16LF7X	—	0.4	2.0	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V **(Note 4)**
D010A			—	20	48	µA	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled
D010		PIC16F7X	-	0.9	4	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 5.5V **(Note 4)**
D013			—	5.2	15	mA	HS osc configuration FOSC = 20 MHz, VDD = 5.5V
D015*	ΔIBOR	**Brown-out Reset Current (Note 6)**	—	25	200	µA	BOR enabled, VDD = 5.0V
D020	IPD	**Power-down Current (Notes 3, 5)**					
		PIC16LF7X	—	2.0	30	µA	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021			—	0.1	5	µA	VDD = 3.0V, WDT disabled, -40°C to +85°C
D020		PIC16F7X	—	5.0	42	µA	VDD = 4.0V, WDT enabled, -40°C to +85°C
D021			—	0.1	19	µA	VDD = 4.0V, WDT disabled, -40°C to +85°C
D021A			—	10.5	57	µA	VDD = 4.0V, WDT enabled, -40°C to +125°C
			—	1.5	42	µA	VDD = 4.0V, WDT disabled, -40°C to +125°C
D023*	ΔIBOR	**Brown-out Reset Current (Note 6)**	—	25	200	µA	BOR enabled, VDD = 5.0V

Legend: Shading of rows is to assist in readability of of the table.
* These parameters are characterized but not tested.
† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature also have an impact on the current consumption.
The test conditions for all IDD measurements in active operation mode are:
OSC1 = external square wave, from-rail to-rail; all I/O pins tri-stated, pulled to VDD
MCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

7: When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.

TABLE 15-12: A/D CONVERTER CHARACTERISTICS: PIC16F7X (INDUSTRIAL, EXTENDED) PIC16LF7X (INDUSTRIAL)

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
A01	NR	Resolution	PIC16F7X	—	—	8 bits	bit	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
			PIC16LF7X	—	—	8 bits	bit	VREF = VDD = 2.2V
A02	EABS	Total absolute error		—	—	< ±1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A03	EIL	Integral linearity error		—	—	< ±1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A04	EDL	Differential linearity error		—	—	< ±1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A05	EFS	Full scale error		—	—	< ±1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A06	EOFF	Offset error		—	—	< ±1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A10	—	Monotonicity **(Note 3)**		—	guaranteed	—	—	VSS ≤ VAIN ≤ VREF
A20	VREF	Reference voltage		2.5 2.2	— —	5.5 5.5	V V	-40°C to +125°C 0°C to +125°C
A25	VAIN	Analog input voltage		VSS - 0.3	—	VREF + 0.3	V	
A30	ZAIN	Recommended impedance of analog voltage source		—	—	10.0	kΩ	
A40	IAD	A/D conversion current (VDD)	PIC16F7X	—	180	—	μA	Average current consumption when A/D is on **(Note 1)**.
			PIC16LF7X	—	90	—	μA	
A50	IREF	VREF input current **(Note 2)**		N/A —	— —	±5 500	μA μA	During VAIN acquisition. During A/D Conversion cycle.

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: When A/D is off, it will not consume any current other than minor leakage current. The power-down current spec includes any such leakage from the A/D module.

2: VREF current is from the RA3 pin or the VDD pin, whichever is selected as a reference input.

3: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

FIGURE 16-9: AVERAGE FOSC vs. VDD FOR VARIOUS VALUES OF R (RC MODE, C = 300 pF, 25°C)

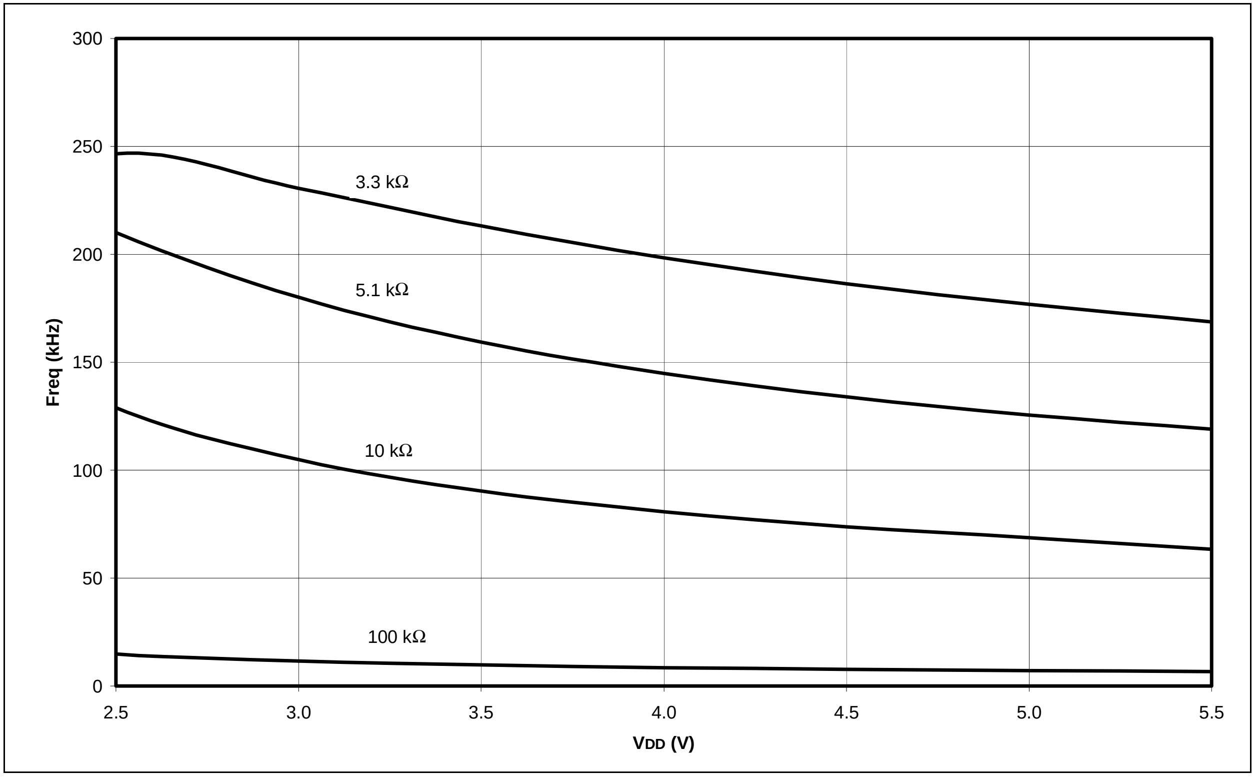
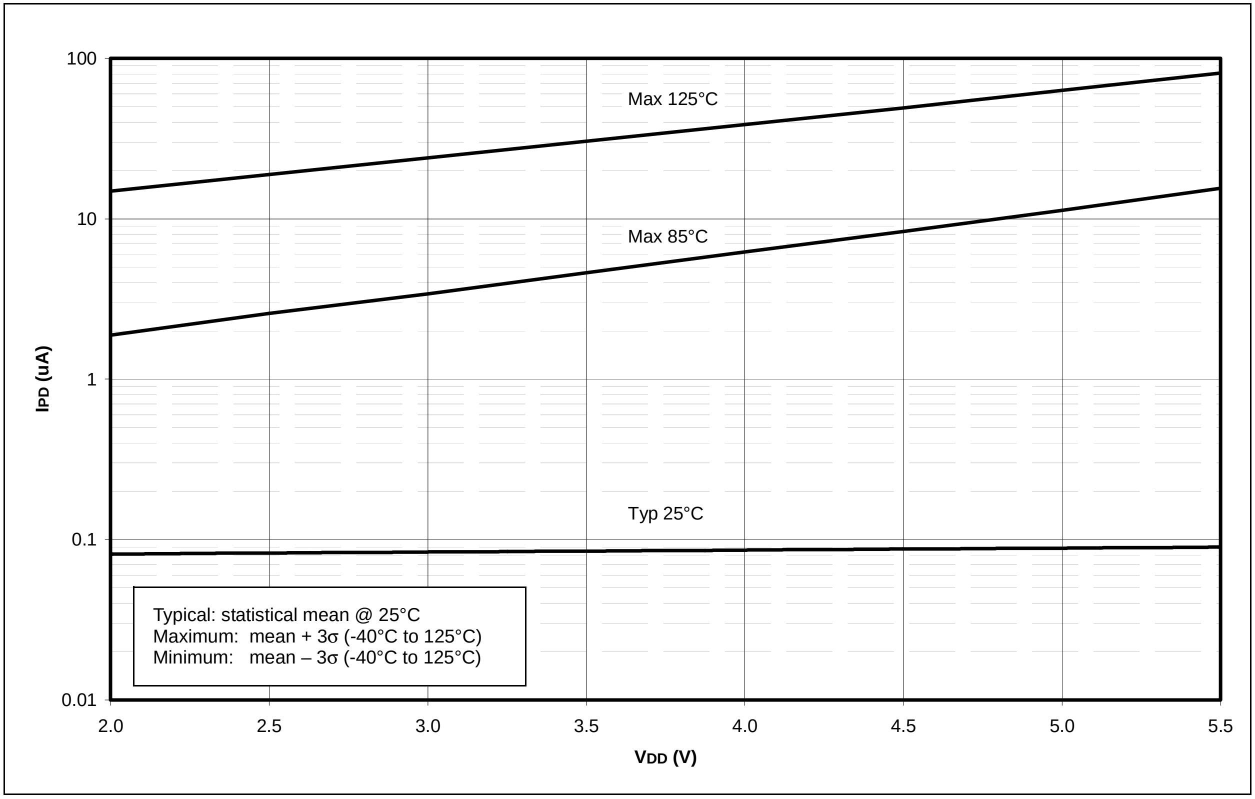


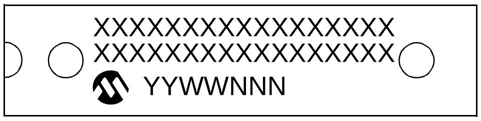
FIGURE 16-10: IPD vs. VDD (SLEEP MODE, ALL PERIPHERALS DISABLED)



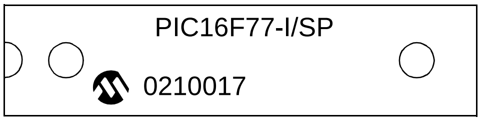
17.0 PACKAGING INFORMATION

17.1 Package Marking Information

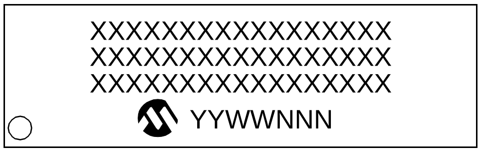
28-Lead PDIP (Skinny DIP)



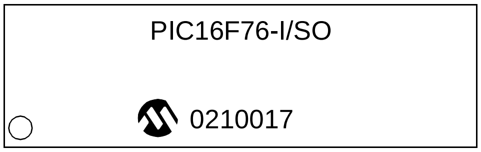
Example



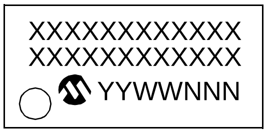
28-Lead SOIC



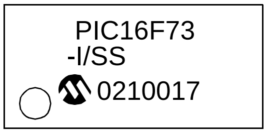
Example



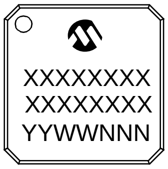
28-Lead SSOP



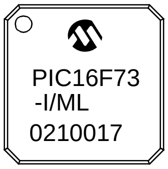
Example



28-Lead MLF



Example



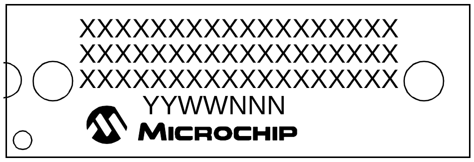
Legend:	XX...X	Customer specific information*
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

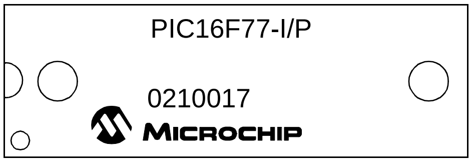
* Standard PICmicro device marking consists of Microchip part number, year code, week code, and traceability code. For PICmicro device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

Package Marking Information (Cont'd)

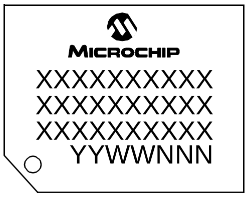
40-Lead PDIP



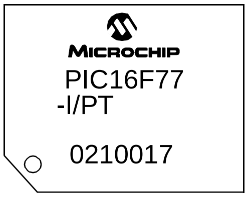
Example



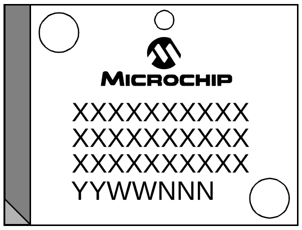
44-Lead TQFP



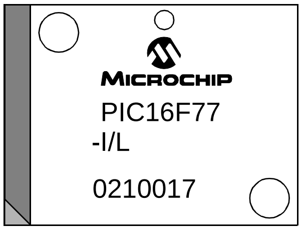
Example



44-Lead PLCC



Example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